

(NOLE I)	
V _{IN} , RUN/SS Voltage	40V
ADJ, R _T , SHARE Voltage	5V
V _{OUT} , AUX	10V
PGOOD, SYNC	30V
BIAS	16V

V _{IN} + BIAS	56V
Internal Operating Temperature	
(Note 2)	40°C to 125°C
Storage Temperature	
Solder Temperature	250°C

SHARE R_T SHARE R_T GND (BANK 3) ADJ GND (BANK 3) ADJ 7 7 SYNC SYNC 6 PGOOD 6 PGOOD 5 RUN/SS RUN/SS 5 BIAS BIAS 4 4 AUX AUX 3 3 V_{OUT} (BANK 2) 2 V_{OUT} (BANK 2) 2 V_{IN} (BANK 1) V_{IN} (BANK 1) 1 1 Е F Н А В С D Е F G Н В С D G А LGA PACKAGE **BGA PACKAGE** 50-LEAD (11.25mm × 9mm × 2.82mm) 50-LEAD (11.25mm × 9mm × 3.42mm) $\begin{array}{l} \mathsf{T}_{JMAX} = 125^\circ C, \, \theta_{JA} = 30.4^\circ C/W, \, \theta_{JCbottom} = 12.2^\circ C/W, \\ \theta_{JCtop} = 23.9^\circ C/W, \, \theta_{JB} = 12.1^\circ C/W, \, WEIGHT = 0.9g \\ \theta \; \mathsf{VALUES} \; \mathsf{DETERMINED} \; \mathsf{PER} \; \mathsf{JEDEC} \; 51\text{-}9, \; 51\text{-}12 \end{array}$ $\begin{array}{l} \mathsf{T}_{JMAX} = 125^\circ\text{C}, \ \theta_{JA} = 32.1^\circ\text{C/W}, \ \theta_{JCbottom} = 14.8^\circ\text{C/W}, \\ \theta_{JCtop} = 23.7^\circ\text{C/W}, \ \theta_{JB} = 14.6^\circ\text{C/W}, \ WEIGHT = 0.9g \\ \theta \ VALUES \ DETERMINED \ PER \ JEDEC \ 51-9, \ 51-12 \end{array}$

PIN CONFIGURATION

ORDER INFORMATION

PART NUMBER	PAD OR BALL FINISH	PART MARKING*		PACKAGE	MSL	TEMPERATURE RANGE	
		DEVICE	FINISH CODE	TYPE	RATING	(Note 2)	
LTM8023EV#PBF	Au (RoHS)	LTM8023V	e4	LGA	3	-40°C to 85°C	
LTM8023IV#PBF	Au (RoHS)	LTM8023V	e4	LGA	3	–40°C to 85°C	
LTM8023MPV#PBF	Au (RoHS)	LTM8023MPV	e4	LGA	3	-55°C to 125°C	
LTM8023EY#PBF	SAC305 (RoHS)	LTM8023Y	e1	BGA	3	-40°C to 85°C	
LTM8023IY#PBF	SAC305 (RoHS)	LTM8023Y	e1	BGA	3	-40°C to 85°C	
LTM8023IY	SnPb (63/37)	LTM8023Y	eO	BGA	3	-40°C to 85°C	
LTM8023MPY#PBF	SAC305 (RoHS)	LTM8023Y	e1	BGA	3	-55°C to 125°C	
LTM8023MPY	SnPb (63/37)	LTM8023Y	eO	BGA	3	-55°C to 125°C	

Consult Marketing for parts specified with wider operating temperature ranges. *Device temperature grade is indicated by a label on the shipping container. Pad or ball finish code is per IPC/JEDEC J-STD-609.

 Terminal Finish Part Marking: www.linear.com/leadfree Recommended LGA and BGA PCB Assembly and Manufacturing
 Procedures:

www.linear.com/umodule/pcbassembly

 LGA and BGA Package and Tray Drawings: www.linear.com/packaging

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ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{IN} = 10V, V_{RUN/SS} = 10V, V_{BIAS} = 3V, R_T = 60.4k, C_{OUT} = 4.7µF unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
V _{IN}	Input DC Voltage			3.6		36	V
V _{OUT}	Output DC Voltage	$\begin{array}{l} 0A < I_{OUT} \leq 2A, \ R_{ADJ} \ Open, \ C_{OUT} = 51 \mu F \ (Note \ 3) \\ 0A < I_{OUT} \leq 2A, \ R_{ADJ} = 43.2k, \ C_{OUT} = 51 \mu F \ (Note \ 3) \end{array}$			0.8 10		V V
R _{ADJ(MIN)}	Minimum Allowable R _{ADJ}	(Note 4)		42.2			kΩ
I _{OUT}	Continuous Output DC Current	$4 \le V_{IN} \le 36$, $C_{OUT} = 51 \mu F$		0		2	A
IQ _{VIN}	V _{IN} Quiescent Current	$ \begin{array}{l} V_{RUN/SS} = 0.2V, \ R_T = 174k \\ V_{BIAS} = 3V, \ Not \ Switching, \ R_T = 174k \ (E, \ I) \\ V_{BIAS} = 3V, \ Not \ Switching, \ R_T = 174k \ (MP) \\ V_{BIAS} = 0V, \ Not \ Switching, \ R_T = 174k \end{array} $	•		0.1 25 25 85	0.5 60 350 120	μΑ μΑ μΑ μΑ
IQ _{BIAS}	BIAS Quiescent Current	$ \begin{array}{l} V_{RUN/SS} = 0.2V, R_T = 174k \\ V_{BIAS} = 3V, Not Switching, R_T = 174k (E, I) \\ V_{BIAS} = 3V, Not Switching, R_T = 174k (MP) \\ V_{BIAS} = 0V, Not Switching, R_T = 174k \end{array} $	•		0.03 50 50 1	0.5 120 200 5	μΑ μΑ μΑ
$\Delta V_{OUT}/V_{OUT}$	Line Regulation	$5 \le V_{IN} \le 36$, $I_{OUT} = 1A$, $V_{OUT} = 3.3V$, $C_{OUT} = 51\mu F$			0.1		%
$\Delta V_{OUT}/V_{OUT}$	Load Regulation	$V_{IN} = 24V, 0 \le I_{OUT} \le 2A, V_{OUT} = 3.3V, C_{OUT} = 51 \mu F$			0.4		%
V _{OUT(AC_RMS)}	Output Ripple (RMS)	V _{IN} = 24V, I _{OUT} = 2A, V _{OUT} = 3.3V, C _{OUT} = 51µF			10		mV
f _{SW}	Switching Frequency	R _T = 113k, C _{OUT} = 51µF			325		kHz
I _{SC(OUT)}	Output Short Circuit Current	V _{IN} = 36V, V _{OUT} = 0V (Note 5)			2.9		A
V _{ADJ}	Voltage at ADJ Pin	$C_{OUT} = 51 \mu F$		765	790	805	mV
V _{BIAS(MIN)}	Minimum BIAS Voltage for Proper Operation				2.3	2.8	V
I _{ADJ}	Current Out of ADJ Pin	$ADJ = 1V, C_{OUT} = 51\mu F$			2		μA
I _{RUN/SS}	RUN/SS Pin Current	V _{RUN/SS} = 2.5V			5	10	μA
V _{IH(RUN/SS)}	RUN/SS Input High Voltage	C _{OUT} = 51µF		2.5			V
VIL(RUN/SS)	RUN/SS Input Low Voltage	C _{OUT} = 51µF				0.2	V
V _{PGOOD(TH)}	PGOOD Threshold	V _{OUT} Rising			730		mV
I _{PGOOD(0)}	PGOOD Leakage	$V_{PGOOD} = 30V$			0.1	1	μA
PGOOD(SINK)	PGOOD Sink Current	V _{PG00D} = 0.4V		200	800		μA
V _{SYNCIL}	SYNC Input Low Threshold	f _{SYNC} = 550kHz, C _{OUT} = 51µF				0.5	V
V _{SYNCIH}	SYNC Input High Threshold	f _{SYNC} = 550kHz, C _{OUT} = 51µF		0.7			V
ISYNCBIAS	SYNC Pin Bias Current	V _{SYNC} = 0V			0.1		μA

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: The LTM8023E is guaranteed to meet performance specifications from 0°C to 85°C ambient. Specifications over the full –40°C to 85°C ambient operating temperature range are assured by design, characterization and correlation with statistical process controls. The LTM8023I is guaranteed to meet specifications over the full -40°C to 85°C ambient operating temperature range. The LTM8023MP is guaranteed to

meet specifications over the full -55°C to 125°C temperature range. Note that the maximum internal temperature is determined by specific operating conditions in conjunction with board layout, the rated package thermal resistance and other environmental factors.

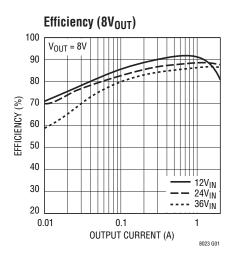
Note 3: $C_{OUT} = 51 \mu F$ is composed of a 4.7 μF ceramic capacitor in parallel with a 47µF electrolytic.

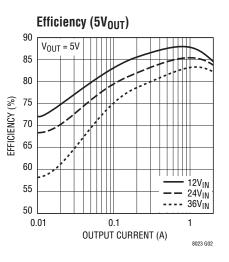
Note 4: Guaranteed by design.

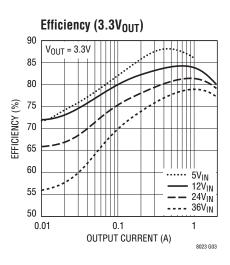
Note 5: Short circuit current at V_{IN} = 36V is guaranteed by characterization and correlation. 100% tested at V_{IN} = 10V



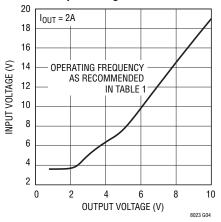
TYPICAL PERFORMANCE CHARACTERISTICS T_A = 25°C unless otherwise noted



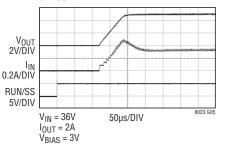




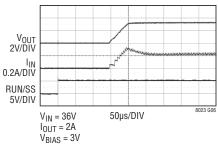
Minimum Required Input Voltage vs Output Voltage

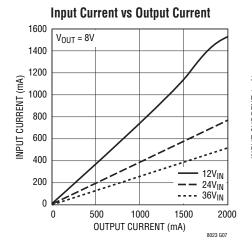


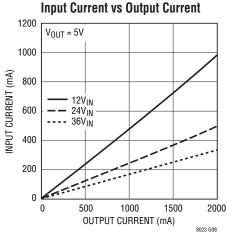
36V_{IN} Start-Up Waveforms (5V_{OUT})



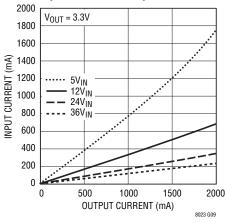
36V_{IN} Start-Up Waveforms (3.3V_{OUT})





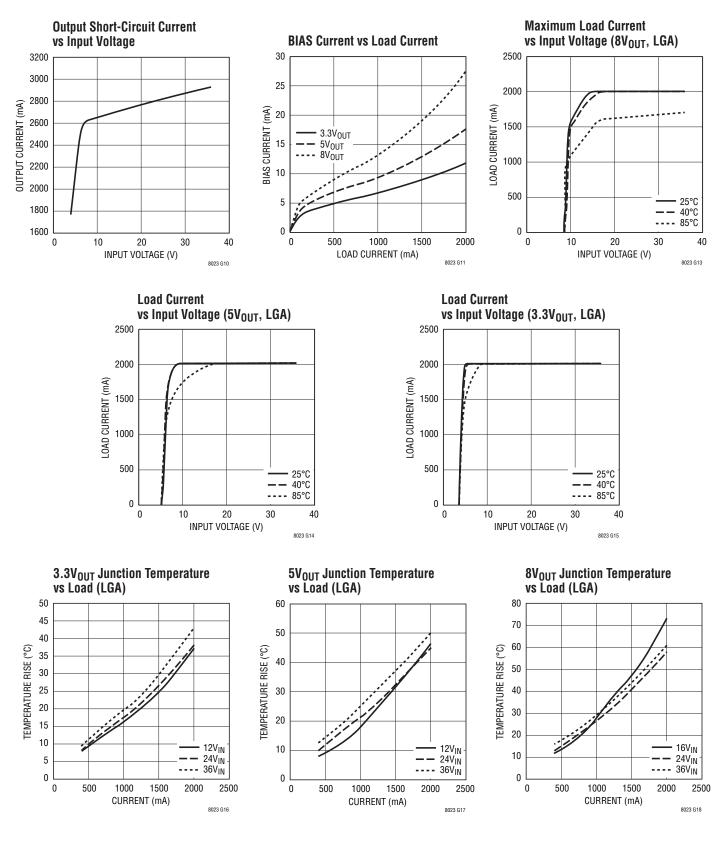


Input Current vs Output Current





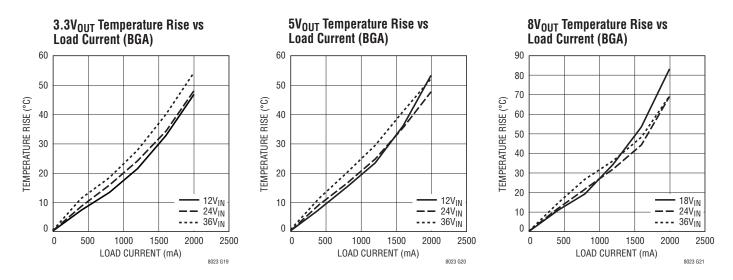
TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^{\circ}C$ unless otherwise noted





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TYPICAL PERFORMANCE CHARACTERISTICS T_A = 25°C unless otherwise noted





PIN FUNCTIONS

 V_{IN} (Bank 1): The V_{IN} pin supplies current to the LTM8023's internal regulator and to the internal power switch. This pin must be locally bypassed with an external, low ESR capacitor of at least 2.2µF.

 V_{OUT} (Bank 2): Power Output Pins. Apply the output filter capacitor and the output load between these pins and GND pins.

AUX (Pin F5): Low Current Voltage Source for BIAS. The V_{AUX} pin is internally connected to V_{OUT} and is placed adjacent to the BIAS pin to ease printed circuit board routing. Although this pin is internally connected to V_{OUT} , do NOT connect this pin to the load. If this pin is not tied to BIAS, leave it floating.

BIAS (Pin G5): The BIAS pin connects to the internal power bus. Connect to a power source greater than 2.8V. If the output is greater than 2.8V, connect this pin there. If the output voltage is less, connect this to a voltage source between 2.8V and 16V. Also, make sure that BIAS + V_{IN} is less than 56V.

RUN/SS (Pin H5): Tie RUN/SS pin to ground to shut down the LTM8023. Tie to 2.5V or more for normal operation. If the shutdown feature is not used, tie this pin to the V_{IN} pin. RUN/SS also provides a soft-start function; see the Applications Information section.

GND (Bank 3): Tie these GND pins to a local ground plane below the LTM8023 and the circuit components. In most applications, the bulk of the heat flow out of the LTM8023 is through these pads, so the printed circuit design has a

large impact on the thermal performance of the part. See the PCB Layout and Thermal Consideration sections for more details. Return the feedback divider (R_{ADJ}) to this net.

 \mathbf{R}_{T} (**Pin G7**): The R_{T} pin is used to program the switching frequency of the LTM8023 by connecting a resistor from this pin to ground. The Applications Information section of the data sheet includes a table to determine the resistance value based on the desired switching frequency. Minimize capacitance at this pin.

SHARE (Pin F7): Tie this to the SHARE pin of another LTM8023 when paralleling the outputs. Otherwise, do not connect (leave floating).

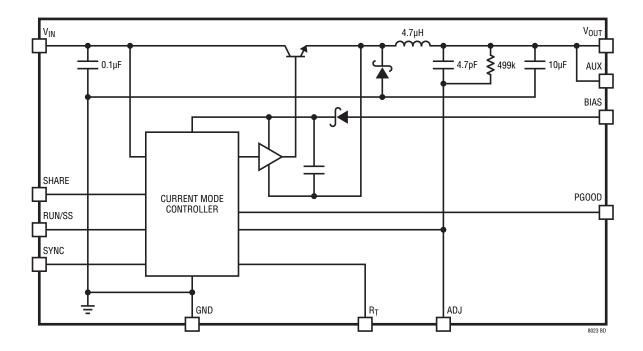
SYNC (Pin G6): This is the external clock synchronization input. Ground this pin for low ripple Burst Mode® operation at low output loads. Tie to a stable voltage source greater than 0.7V to disable Burst Mode operation. *Do not leave this pin floating*. Tie to a clock source for synchronization. Clock edges should have rise and fall times faster than 1µs. See synchronizing section in Applications Information.

PGOOD (Pin H6): The PGOOD pin is the open-collector output of an internal comparator. PG remains low until the ADJ pin is within 10% of the final regulation voltage. PG output is valid when V_{IN} is above 3.6V and RUN/SS is high. If this function is not used, leave this pin floating.

ADJ (Pin H7): The LTM8023 regulates its ADJ pin to 0.79V. Connect the adjust resistor from this pin to ground. The value of R_{ADJ} is given by the equation $R_{ADJ} = 394.21/$ ($V_{OUT} - 0.79$), where R_{ADJ} is in k Ω .



BLOCK DIAGRAM





OPERATION

The LTM8023 is a standalone nonisolated step-down switching DC/DC power supply. It can deliver up to 2A of DC output current with only bulk external input and output capacitors. This module provides a precisely regulated output voltage programmable via one external resistor from $0.8V_{DC}$ to $10V_{DC}$. The input voltage range is 3.6V to 36V. Given that the LTM8023 is a step-down converter, make sure that the input voltage is high enough to support the desired output voltage and load current. A simplified Block Diagram is given on the previous page.

The LTM8023 contains a current mode controller, power switching element, power inductor, power Schottky diode and a modest amount of input and output capacitance.

The LTM8023 is a fixed frequency PWM regulator. The switching frequency is set by simply connecting the appropriate resistor value from the R_T pin to GND.

An internal regulator provides power to the control circuitry. The bias regulator normally draws power from the $V_{\rm IN}$ pin, but if the BIAS pin is connected to an external

voltage higher than 2.8V, bias power will be drawn from the external source (typically the regulated output voltage). This improves efficiency. The RUN/SS pin is used to place the LTM8023 in shutdown, disconnecting the output and reducing the input current to less than 1μ A.

To further optimize efficiency, the LTM8023 automatically switches to Burst Mode operation in light load situations. Between bursts, all circuitry associated with controlling the output switch is shut down reducing the input supply current to 50μ A in a typical application. The oscillator reduces the LTM8023's operating frequency when the voltage at the ADJ pin is low. This frequency foldback helps to control the output current during start-up and overload.

The LTM8023 contains a power good comparator which trips when the ADJ pin is at 92% of its regulated value. The PGOOD output is an open-collector transistor that is off when the output is in regulation, allowing an external resistor to pull the PGOOD pin high. Power good is valid when the LTM8023 is enabled and $V_{\rm IN}$ is above 3.6V.

APPLICATIONS INFORMATION

For most applications, the design process is straight forward, summarized as follows:

- 1. Look at Table 1 and find the row that has the desired input range and output voltage.
- 2. Apply the recommended C_{IN} , C_{OUT} , R_{ADJ} and R_T values.
- 3. Connect BIAS as indicated.

While these component combinations have been tested for proper operation, it is incumbent upon the user to verify proper operation over the intended system's line, load and environmental conditions.

Capacitor Selection Considerations

The C_{IN} and C_{OUT} capacitor values in Table 1 are the minimum recommended values for the associated operating conditions. Applying capacitor values below those

indicated in Table 1 is not recommended, and may result in undesirable operation. Using larger values is generally acceptable, and can yield improved dynamic response, if it is necessary. Again, it is incumbent upon the user to verify proper operation over the intended system's line, load and environmental conditions.

Ceramic capacitors are small, robust and have very low ESR. However, not all ceramic capacitors are suitable. X5R and X7R types are stable over temperature and applied voltage and give dependable service. Other types, including Y5V and Z5U have very large temperature and voltage coefficients of capacitance. In an application circuit they may have only a small fraction of their nominal capacitance resulting in much higher output voltage ripple than expected.





Table 1. Recommended Component Values and Configuration (T_A = 25°C)

3.8V 1.0V 10µF 14µF 1266 1.87M 2.2.8V, .16V 300 124k 300 12 3.6V to 80V 1.20V 10µF 100µF 1206 953k 2.2.8V, .16V 350 105k 350 00 88.7k 400 78k 500 69.8k 45.0 77k 450 77k 450 77k 500 69.8k 550 61 44.7k 430 78k 500 69.8k 550 61 44.7k 430 78k 500 42.8V, .16V 550 61.9k 650 439.8k 550 42 55V to 80V 2.2µF 10µF 200µF 1206 134k AUX 650 439.8k 650 43 36V to 15V 1.00V 10µF 10µF 1206 2.8k Vµµ 450 79k 100 2.8 38 38V to 15V 1.00V </th <th>V_{IN}</th> <th>V_{OUT}</th> <th>CIN</th> <th>C_{OUT}</th> <th>R_{ADJ}</th> <th>BIAS</th> <th>f_{optimal} (kHz)</th> <th>R_{T(OPTIMAL)}</th> <th>f_{MAX} (kHz)</th> <th>R_{T(MIN}</th>	V _{IN}	V _{OUT}	CIN	C _{OUT}	R _{ADJ}	BIAS	f _{optimal} (kHz)	R _{T(OPTIMAL)}	f _{MAX} (kHz)	R _{T(MIN}
3.6V 1.20V 10µF 100µF 100µF 1206 953k 22.8V, <16V 350 110k 360 100 3.6V to 36V 1.50V 1.0µF 100µF 1206 549k 22.8V, <16V	3.6V to 36V	0.82V	10µF	200µF 1206	13M	≥2.8V, <16V	250	150k	250	150k
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	3.6V to 36V	1.00V	10µF	147µF 1206	1.87M	≥2.8V, <16V	300	124k	300	124k
3.6V 1.80V 4.7µF 100µF 1206 383k ≥2.8V, <16V 450 79k 450 69 3.6V to 86V 2.00V 2.2µF 4.1µF 1206 324k ≥2.8V, <16V	3.6V to 36V	1.20V	10µF	100µF 1206	953k	≥2.8V, <16V	350	105k	350	105k
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	3.6V to 36V	1.50V	10µF	100µF 1206	549k	≥2.8V, <16V	400	88.7k	400	88.7k
3.6V 1.6V 2.20V 2.2µF 47µF 1206 274k ≥2.8V,<16V 500 69.8k 550 61 4.1V to 86V 2.20µF 2µF 12µF	3.6V to 36V	1.80V	4.7µF	100µF 1206	383k	≥2.8V, <16V	450	79k	450	79k
4.1V to 36V 2.2,bV 4.2,bV 4.1V to 36V 2.2,bF 4.1V to 36V 5.5V to 36V 3.30V 2.2,pF 122,pF 120,pF 123,pF	3.6V to 36V	2.00V	2.2µF	68µF 1206	324k	≥2.8V, <16V	450	79k	500	69.8k
5.5V to 36V 3.30V 2.2µF 22µF1206 154k AUX 660 49.9k 890 34 7.5V to 36V 5.00V 2.2µF 10µF 0605 93.1k AUX 660 49.9k 890 34 3.6V to 15V 0.02V 10µF 10µF <td< td=""><td>3.6V to 36V</td><td>2.20V</td><td>2.2µF</td><td>47µF 1206</td><td>274k</td><td>≥2.8V, <16V</td><td>500</td><td>69.8k</td><td>550</td><td>61.9k</td></td<>	3.6V to 36V	2.20V	2.2µF	47µF 1206	274k	≥2.8V, <16V	500	69.8k	550	61.9k
7.5V to 36V 5.00V 2.2μ F 10 μ F 0805 93.1k AUX 660 49.9k 890 34 3.6V to 15V 0.82V 10 μ F 200 μ F 1206 13M V _N 350 105k 650 49 3.6V to 15V 1.20V 10 μ F 100 μ F 1206 653k V _N 450 79k 800 39 3.6V to 15V 1.20V 10 μ F 100 μ F 1206 643k V _N 450 79k 1000 29 3.6V to 15V 1.80V 4.7 μ F 100 μ F 1206 334k V _N 450 79k 1000 23 3.6V to 15V 2.00V 2.2 μ F 68 μ F 1206 324k V _N 450 79k 1200 23 3.6V to 15V 2.00V 2.2 μ F 47 μ F 1206 226k V _N 550 61.9 k 1450 18 5.5V to 15V 5.00V 2.2 μ F 10 μ F 1206 13M 2.2 k V, <16V	4.1V to 36V	2.50V	2.2µF	47µF 1206	226k	≥2.8V, <16V	550	61.9k	615	54.9k
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	5.5V to 36V	3.30V	2.2µF	22µF 1206	154k	AUX	650	49.9k	750	42.2k
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	7.5V to 36V	5.00V	2.2µF	10µF 0805	93.1k	AUX	650	49.9k	890	34.8k
3.6V to 15V 1.00V 10µF 147µF 1206 1.87M V _{IN} 400 88.7k 725 43 3.6V to 15V 1.20V 10µF 100µF 1206 533k V _{IN} 450 79k 800 39 3.6V to 15V 1.80V 4.7µF 100µF 1206 549k V _{IN} 450 79k 1100 28 3.6V to 15V 2.80V 2.2µF 68µF 1206 324k V _{IN} 450 79k 1200 23 3.6V to 15V 2.20V 2.2µF 47µF 1206 224k V _{IN} 550 61.9k 1400 19 5.5V to 15V 3.30V 2.2µF 10µF 1206 134k AUX 650 49.9k 1400 19 7.5V to 15V 5.00V 0.2µF 10µF 1206 133k 2.2R_V 150V 250V 150K 250 155 9V to 24V 1.00V 10µF 147µF 1206 1.87M 2.2R_V 450 79k 700 44	3.6V to 15V	0.82V	10µF	200µF 1206	13M	V _{IN}	350	105k	650	49.9k
3.6V to 15V 1.20V 10µF 100µF 1206 953k V _{IN} 450 79k 800 39 3.6V to 15V 1.50V 4.7µF 100µF 1206 383k V _{IN} 450 79k 1000 29 3.6V to 15V 2.00V 2.2µF 68µF 1206 324k V _{IN} 450 79k 1100 26 3.6V to 15V 2.00V 2.2µF 47µF 1206 274k V _{IN} 550 61.9k 1450 178 3.6V to 15V 2.50V 2.2µF 24µF 1206 226k V _{IN} 550 61.9k 1450 18 3.6V to 15V 5.00V 2.2µF 10µF 0805 93.1k AUX 650 49.9k 1400 19 7.5V to 15V 5.00V 2.2µF 10µF 1206 13M 2.2N, <16V	3.6V to 15V	1.00V	10µF	147µF 1206	1.87M		400	88.7k	725	43.2k
$3.6V to 15V$ $1.50V$ 10μ F 100μ F 1206 $549k$ V_{IN} 450 $79k$ 1000 293 $3.6V to 15V$ $2.00V$ 2.2μ F 68μ F 1206 $324k$ V_{IN} 450 $79k$ 1200 223 $3.6V to 15V$ $2.20V$ 2.2μ F 47μ F 1206 $274k$ V_{IN} 550 $61.9k$ 1450 18 $3.6V to 15V$ $2.30V$ 2.2μ F 47μ F 1206 $226k$ V_{IN} 550 $61.9k$ 1400 19 $5.5V to 15V$ $3.00V$ 2.2μ F 10μ F 200μ F 1206 $13M$ $2.8V, <16V$ 500 $49.9k$ 1400 19 $9V to 24V$ $1.00V$ 10μ F 147μ F 1206 $18.7M$ $22.8V, <16V$ 300 $124k$ 450 $79k$ 615 54 $9V to 24V$ $1.00V$ 2.2μ F 100μ F 1206 $549k$ $2.8V, <16V$ 450 $79k$ 615 54 $9V to 24V$ $2.00V$ <	3.6V to 15V	1.20V	10µF	100µF 1206	953k		450	79k	800	39.2k
3.6V to 15V 1.80V 4.7μ F 100 μ F 1206 383k V_{IN} 450 79k 1100 26 3.6V to 15V 2.00V 2.2 μ F 68 μ F 1206 324k V_{IN} 450 79k 1200 23 3.6V to 15V 2.20V 2.2 μ F 47 μ F 1206 274k V_{IN} 500 69.8k 1300 21 3.6V to 15V 2.50V 2.2 μ F 47 μ F 1206 226k V_{IN} 550 61.9k 1450 18 5.5V to 15V 3.30V 2.2 μ F 10 μ F 0200 93.1k AUX 650 49.9k 1400 19 7.5V to 15V 5.00V 2.2 μ F 10 μ F 2006 13M \geq 2.8V,<16V	3.6V to 15V	1.50V	10µF	100µF 1206	549k	1	450	79k	1000	29.4k
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	3.6V to 15V	1.80V	4.7µF	100µF 1206	383k		450	79k	1100	26.7k
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	3.6V to 15V	2.00V	2.2µF	68µF 1206	324k		450	79k	1200	23.7k
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	3.6V to 15V	2.20V	2.2µF	47µF 1206	274k		500	69.8k	1300	21.0k
5.5V to 15V3.30V2.2 μ F22 μ F 1206154kAUX65049.9k1400197.5V to 15V5.00V2.2 μ F10 μ F 080593.1kAUX66049.9k1200239V to 24V0.82V10 μ F200 μ F 120613M>2.8V, <16V	3.6V to 15V	2.50V	2.2µF	47µF 1206	226k		550	61.9k	1450	18.2k
7.5V to 15V5.00V 2.2μ F 10μ F 0805 $93.1k$ AUX650 $49.9k$ 1200 23 9V to 24V $0.82V$ 10μ F 200μ F 1206 $13M$ $\geq 2.8V, <16V$ 250 $150k$ 250 15 9V to 24V $1.00V$ 10μ F 147μ F 1206 $1.87M$ $\geq 2.8V, <16V$ 300 $124k$ 450 77 9V to 24V $1.20V$ 2.2μ F 100μ F 1206 $953k$ $\geq 2.8V, <16V$ 450 $79k$ 500 69 9V to 24V $1.50V$ 2.2μ F 100μ F 1206 $549k$ $\geq 2.8V, <16V$ 450 $79k$ 700 44 9V to 24V $2.20V$ 2.2μ F 100μ F 1206 $324k$ $\geq 2.8V, <16V$ 450 $79k$ 700 44 9V to 24V $2.00V$ 2.2μ F 68μ F 1206 $324k$ $\geq 2.8V, <16V$ 450 $79k$ 750 42 9V to 24V $2.00V$ 2.2μ F 47μ F 1206 $274k$ $\geq 2.8V, <16V$ 450 $79k$ 750 42 9V to 24V $2.50V$ 2.2μ F 47μ F 1206 $226k$ $\geq 2.8V, <16V$ 550 $61.9k$ 890 34 9V to 24V $3.30V$ 2.2μ F 47μ F 1206 $226k$ $\geq 2.8V, <16V$ 550 $61.9k$ 800 39 9V to 24V $3.00V$ 2.2μ F 10μ F 0805 $53.6k$ AUX 650 $49.9k$ 1100 29 14.5V to 24V $8.00V$ 2.2μ F 10μ F 0805 $53.6k$ AUX 650 $49.9k$ 300 <td< td=""><td>5.5V to 15V</td><td>3.30V</td><td></td><td>22µF 1206</td><td>154k</td><td></td><td>650</td><td>49.9k</td><td>1400</td><td>19.6k</td></td<>	5.5V to 15V	3.30V		22µF 1206	154k		650	49.9k	1400	19.6k
$\begin{array}{c c c c c c c c c c c c c c c c c c c $					93.1k	AUX	650		1200	23.7
9V to 24V1.00V10µF147µF 12061.87M $\geq 2.8V, <16V$ 300124k450739V to 24V1.20V2.2µF100µF 1206953k $\geq 2.8V, <16V$ 45079k500699V to 24V1.80V2.2µF100µF 1206549k $\geq 2.8V, <16V$ 45079k615549V to 24V1.80V2.2µF100µF 1206383k $\geq 2.8V, <16V$ 45079k700449V to 24V2.0V2.2µF68µF 1206324k $\geq 2.8V, <16V$ 45079k750429V to 24V2.20V2.2µF47µF 1206274k $\geq 2.8V, <16V$ 55069.8k800399V to 24V2.50V2.2µF47µF 1206226k $\geq 2.8V, <16V$ 55061.9k890349V to 24V3.30V2.2µF10µF 080593.1kAUX65049.9k11002914.5V to 24V8.00V2.2µF10µF 080553.6kAUX65049.9k10002914.5V to 24V8.00V2.2µF10µF 080553.6kAUX65049.9k8003918V to 36V1.00V10µF147µF 12061.87M $\geq 2.8V, <16V$ 300124k3001218V to 36V1.00V10µF10µF 12061.87M $\geq 2.8V, <16V$ 350105k3501018V to 36V1.20V2.2µF10µF 1206324k $\geq 2.8V, <16V$ 300124k3001218	9V to 24V			200µF 1206		≥2.8V, <16V	250	150k	250	150k
9V to 24V1.20V2.2 μ F100 μ F 1206953 k $\geq 2.8V, <16V$ 45079 k 500699V to 24V1.50V2.2 μ F100 μ F 1206549 k $\geq 2.8V, <16V$ 45079 k 615549V to 24V1.80V2.2 μ F100 μ F 1206383 k $\geq 2.8V, <16V$ 45079 k 700449V to 24V2.00V2.2 μ F68 μ F 1206324 k $\geq 2.8V, <16V$ 45079 k 750429V to 24V2.20V2.2 μ F47 μ F 1206274 k $\geq 2.8V, <16V$ 55061.9 k 800399V to 24V2.50V2.2 μ F47 μ F 1206226 k $\geq 2.8V, <16V$ 55061.9 k 890349V to 24V3.30V2.2 μ F22 μ F 120 ϵ 154 k AUX65049.9 k 1150259V to 24V5.00V2.2 μ F10 μ F 080593.1 k AUX65049.9 k 10002914.5V to 24V8.00V2.2 μ F10 μ F 080553.6 k AUX65049.9 k 3001218V to 36V0.82V10 μ F20 μ F 120613M $\geq 2.8V, <16V$ 300124 k 3001218V to 36V1.20V2.2 μ F10 μ F 1206953 k $\geq 2.8V, <16V$ 300124 k 3001218V to 36V1.80V2.2 μ F10 μ F 1206324 k $\geq 2.8V, <16V$ 300124 k 3001218V to 36V1.80V2.2 μ F10 μ F 12063			10µF				300	124k	450	79k
9V to 24V1.50V 2.2μ F100µF 1206549k $\ge 2.8V, <16V$ 45079k615549V to 24V1.80V 2.2μ F100µF 1206383k $\ge 2.8V, <16V$ 45079k700449V to 24V2.00V 2.2μ F68µF 1206324k $\ge 2.8V, <16V$ 45079k750429V to 24V2.20V 2.2μ F47µF 1206274k $\ge 2.8V, <16V$ 50069.8k800399V to 24V2.50V 2.2μ F47µF 1206226k $\ge 2.8V, <16V$ 55061.9k890349V to 24V3.30V 2.2μ F22µF 1206154kAUX65049.9k1150259V to 24V5.00V 2.2μ F10µF 080593.1kAUX65049.9k10002914.5V to 24V8.00V 2.2μ F10µF 080553.6kAUX65049.9k8003918V to 36V1.00V10µF147µF 12061.87M $\ge 2.8V, <16V$ 300124k3001218V to 36V1.20V 2.2μ F100µF 1206538k $\ge 2.8V, <16V$ 45079k45079k18V to 36V1.20V 2.2μ F100µF 1206549k $\ge 2.8V, <16V$ 45079k45079k18V to 36V1.20V 2.2μ F100µF 1206549k $\ge 2.8V, <16V$ 45079k45079k18V to 36V1.20V 2.2μ F100µF 1206383k $\ge 2.8V, <16V$ 45079k550<							450		500	69.8k
9V to 24V1.80V 2.2μ F100µF 1206383k $\ge 2.8V, <16V$ 45079k700449V to 24V2.00V 2.2μ F 68μ F 1206 $324k$ $\ge 2.8V, <16V$ 45079k750429V to 24V2.20V 2.2μ F 47μ F 1206 $274k$ $\ge 2.8V, <16V$ 500 $69.8k$ 800399V to 24V2.50V 2.2μ F 47μ F 1206226k $\ge 2.8V, <16V$ 550 $61.9k$ 890349V to 24V3.30V 2.2μ F 22μ F 1206154kAUX65049.9k1150259V to 24V5.00V 2.2μ F10µF 080593.1kAUX65049.9k10002914.5V to 24V8.00V 2.2μ F10µF 080553.6kAUX65049.9k8003918V to 36V1.00V10µF200µF 120613M $\ge 2.8V, <16V$ 250150k2501518V to 36V1.20V 2.2μ F100µF 12061.87M $\ge 2.8V, <16V$ 300124k3001218V to 36V1.20V 2.2μ F100µF 1206549k $\ge 2.8V, <16V$ 45079k45079k18V to 36V1.80V 2.2μ F100µF 1206549k $\ge 2.8V, <16V$ 45079k45079k18V to 36V1.80V 2.2μ F100µF 1206324k $\ge 2.8V, <16V$ 45079k5506118V to 36V2.00V 2.2μ F100µF 1206324k $\ge 2.8V, <16V$ 45079k </td <td></td> <td></td> <td></td> <td>· ·</td> <td></td> <td></td> <td>450</td> <td>79k</td> <td>615</td> <td>54.9k</td>				· ·			450	79k	615	54.9k
9V to 24V2.00V2.2µF68µF 1206324k $\geq 2.8V, <16V$ 45079k750429V to 24V2.20V2.2µF47µF 1206274k $\geq 2.8V, <16V$ 50069.8k800399V to 24V2.50V2.2µF47µF 1206226k $\geq 2.8V, <16V$ 55061.9k890349V to 24V3.30V2.2µF22µF10µF 080593.1kAUX65049.9k1150259V to 24V5.00V2.2µF10µF 080553.6kAUX65049.9k10002914.5V to 24V8.00V2.2µF10µF 080553.6kAUX65049.9k8003918V to 36V0.82V10µF20µF 120613M $\geq 2.8V, <16V$ 300124k3001218V to 36V1.00V10µF147µF 12061.87M $\geq 2.8V, <16V$ 300124k3001218V to 36V1.20V2.2µF100µF 1206953k $\geq 2.8V, <16V$ 350105k3501018V to 36V1.50V2.2µF100µF 1206549k $\geq 2.8V, <16V$ 45079k4507918V to 36V1.80V2.2µF68µF 1206324k $\geq 2.8V, <16V$ 45079k4507918V to 36V2.20V2.2µF68µF 1206324k $\geq 2.8V, <16V$ 45079k5506118V to 36V2.20V2.2µF68µF 1206324k $\geq 2.8V, <16V$ 45079k55061		1.80V			383k		450	79k	700	44.2
9V to 24V2.20V2.2 μ F47 μ F 1206274k>2.8V, <16V50069.8k800399V to 24V2.50V2.2 μ F47 μ F 1206226k>2.8V, <16V		2.00V			324k		450	79k	750	42.2
9V to 24V2.50V2.2 μ F47 μ F 1206226k $\geq 2.8V, < 16V$ 55061.9k890349V to 24V3.30V2.2 μ F22 μ F 1206154kAUX65049.9k1150259V to 24V5.00V2.2 μ F10 μ F 080593.1kAUX65049.9k10002914.5V to 24V8.00V2.2 μ F10 μ F 080553.6kAUX65049.9k8003918V to 36V0.82V10 μ F200 μ F 120613M $\geq 2.8V, < 16V$ 250150k2501518V to 36V1.00V10 μ F147 μ F 12061.87M $\geq 2.8V, < 16V$ 300124k3001218V to 36V1.20V2.2 μ F100 μ F 1206953k $\geq 2.8V, < 16V$ 350105k3501018V to 36V1.50V2.2 μ F100 μ F 1206549k $\geq 2.8V, < 16V$ 40088.7k4008818V to 36V1.80V2.2 μ F100 μ F 1206324k $\geq 2.8V, < 16V$ 45079k45079k18V to 36V2.00V2.2 μ F100 μ F 1206324k $\geq 2.8V, < 16V$ 45079k5506118V to 36V2.20V2.2 μ F100 μ F 1206324k $\geq 2.8V, < 16V$ 45079k5506118V to 36V2.20V2.2 μ F100 μ F 1206324k $\geq 2.8V, < 16V$ 45079k5506118V to 36V2.50V2.2 μ F10 μ F 1206274k $\geq 2.8V, < 16V$ <		-		· ·			500	69.8k	800	39.2k
9V to 24V $3.30V$ 2.2μ F 22μ F 1206 $154k$ AUX 650 $49.9k$ 1150 25 9V to 24V $5.00V$ 2.2μ F 10μ F 0805 $93.1k$ AUX 650 $49.9k$ 1000 29 $14.5V$ to 24V $8.00V$ 2.2μ F 10μ F 0805 $53.6k$ AUX 650 $49.9k$ 800 39 $18V$ to $36V$ $0.82V$ 10μ F 200μ F 1206 $13M$ $\geq 2.8V, <16V$ 250 $150k$ 250 15 $18V$ to $36V$ $1.00V$ 10μ F 147μ F 1206 $1.87M$ $\geq 2.8V, <16V$ 300 $124k$ 300 12 $18V$ to $36V$ $1.20V$ 2.2μ F 100μ F 1206 $953k$ $\geq 2.8V, <16V$ 350 $105k$ 350 100 $18V$ to $36V$ $1.20V$ 2.2μ F 100μ F 1206 $549k$ $\geq 2.8V, <16V$ 400 $88.7k$ 400 88 $18V$ to $36V$ $1.80V$ 2.2μ F 100μ F 1206 $549k$ $\geq 2.8V, <16V$ 400 $88.7k$ 400 88 $18V$ to $36V$ $1.80V$ 2.2μ F 100μ F 1206 $324k$ $\geq 2.8V, <16V$ 450 $79k$ 550 61 $18V$ to $36V$ $2.20V$ 2.2μ F 100μ F 1206 $324k$ $\geq 2.8V, <16V$ 450 $79k$ 550 61 $18V$ to $36V$ $2.20V$ 2.2μ F 47μ F 1206 $274k$ $\geq 2.8V, <16V$ 450 $79k$ 550 61 $18V$ to $36V$ $2.50V$ 2.2μ F 47μ F 1206 $226k$ $\geq 2.8V, <16$					226k		550	61.9k	890	34.8
9V to 24V5.00V2.2 μ F10 μ F 080593.1kAUX65049.9k10002914.5V to 24V8.00V2.2 μ F10 μ F 080553.6kAUX65049.9k8003918V to 36V0.82V10 μ F200 μ F 120613M \geq 2.8V, <16V		3.30V			154k		650		1150	25.5
$\begin{array}{c c c c c c c c c c c c c c c c c c c $					93.1k		650		1000	29.4
$\begin{array}{c c c c c c c c c c c c c c c c c c c $				· ·					800	39.2
$\begin{array}{c c c c c c c c c c c c c c c c c c c $				· ·						150k
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$										124k
18V to 36V1.50V2.2µF100µF 1206549k≥2.8V, <16V40088.7k4008818V to 36V1.80V2.2µF100µF 1206383k≥2.8V, <16V										105k
$\begin{array}{c c c c c c c c c c c c c c c c c c c $		1	i	1			++			88.7
18V to 36V2.00V2.2μF68μF 1206324k≥2.8V, <16V45079k5006918V to 36V2.20V2.2μF47μF 1206274k≥2.8V, <16V							++			79k
18V to 36V2.20V2.2µF47µF 1206274k≥2.8V, <16V45079k5506118V to 36V2.50V2.2µF47µF 1206226k≥2.8V, <16V										69.8
18V to 36V2.50V2.2μF47μF 1206226k≥2.8V, <16V50069.8k6155418V to 36V3.30V2.2μF22μF 1206154kAUX65049.9k7504218V to 36V5.00V2.2μF10μF 080593.1kAUX80039.2k8903418V to 36V8.00V2.2μF10μF 080553.6kAUX65049.9k8003920V to 36V10.00V2.2μF10μF 080542.2kAUX61554.9k750424.75V to 32V-3.30V2.2μF10μF 080542.2kAUX61554.9k750424.75V to 32V-3.30V2.2μF22μF 1206154kAUX55061.9k800397V to 31V-5.00V2.2μF10μF 080593.1kAUX80039.2k11002615V to 28V-8.00V2.2μF10μF 080553.6kAUX80039.2k160015		1					+		-	61.9
18V to 36V 3.30V 2.2µF 22µF 1206 154k AUX 650 49.9k 750 42 18V to 36V 5.00V 2.2µF 10µF 0805 93.1k AUX 800 39.2k 890 34 18V to 36V 8.00V 2.2µF 10µF 0805 53.6k AUX 650 49.9k 800 39 20V to 36V 10.00V 2.2µF 10µF 0805 42.2k AUX 615 54.9k 750 42 4.75V to 32V -3.30V 2.2µF 22µF 1206 154k AUX 615 54.9k 750 42 4.75V to 32V -3.30V 2.2µF 22µF 1206 154k AUX 550 61.9k 800 39 7V to 31V -5.00V 2.2µF 10µF 0805 93.1k AUX 800 39.2k 1100 26 15V to 28V -8.00V 2.2µF 10µF 0805 53.6k AUX 800 39.2k 1600 15		+		· ·			++			54.9
18V to 36V 5.00V 2.2μF 10μF 0805 93.1k AUX 800 39.2k 890 34 18V to 36V 8.00V 2.2μF 10μF 0805 53.6k AUX 650 49.9k 800 39 20V to 36V 10.00V 2.2μF 10μF 0805 42.2k AUX 615 54.9k 750 42 4.75V to 32V -3.30V 2.2μF 22μF 1206 154k AUX 550 61.9k 800 39 7V to 31V -5.00V 2.2μF 10μF 0805 93.1k AUX 800 39.2k 1100 26 15V to 28V -8.00V 2.2μF 10μF 0805 53.6k AUX 800 39.2k 1600 15		-								42.2
18V to 36V 8.00V 2.2μF 10μF 0805 53.6k AUX 650 49.9k 800 39 20V to 36V 10.00V 2.2μF 10μF 0805 42.2k AUX 615 54.9k 750 42 4.75V to 32V -3.30V 2.2μF 22μF 1206 154k AUX 550 61.9k 800 39 7V to 31V -5.00V 2.2μF 10μF 0805 93.1k AUX 800 39.2k 1100 26 15V to 28V -8.00V 2.2μF 10μF 0805 53.6k AUX 800 39.2k 1600 15							++			34.8
20V to 36V 10.00V 2.2μF 10μF 0805 42.2k AUX 615 54.9k 750 42 4.75V to 32V -3.30V 2.2μF 22μF 1206 154k AUX 550 61.9k 800 39 7V to 31V -5.00V 2.2μF 10μF 0805 93.1k AUX 800 39.2k 1100 26 15V to 28V -8.00V 2.2μF 10μF 0805 53.6k AUX 800 39.2k 1600 15							++			39.2
4.75V to 32V -3.30V 2.2μF 22μF 1206 154k AUX 550 61.9k 800 39 7V to 31V -5.00V 2.2μF 10μF 0805 93.1k AUX 800 39.2k 1100 26 15V to 28V -8.00V 2.2μF 10μF 0805 53.6k AUX 800 39.2k 1600 15										42.2
7V to 31V -5.00V 2.2μF 10μF 0805 93.1k AUX 800 39.2k 1100 26 15V to 28V -8.00V 2.2μF 10μF 0805 53.6k AUX 800 39.2k 1100 26		1								39.2
15V to 28V -8.00V 2.2μF 10μF 0805 53.6k AUX 800 39.2k 1600 15							++			26.7
		1	1				++			15.8
pulk input capacitor is required.					00.0K		000	00.2N	1000	15.0

A bulk input capacitor is required.



Ceramic capacitors are also piezoelectric. In Burst Mode operation, the LTM8023's switching frequency depends on the load current, and can excite a ceramic capacitor at audio frequencies, generating audible noise. Since the LTM8023 operates at a lower current limit during Burst Mode operation, the noise is typically very quiet to a casual ear.

If this audible noise is unacceptable, use a high performance electrolytic capacitor at the output. The input capacitor can be a parallel combination of a 2.2μ F ceramic capacitor and a low cost electrolytic capacitor.

A final precaution regarding ceramic capacitors concerns the maximum input voltage rating of the LTM8023. A ceramic input capacitor combined with trace or cable inductance forms a high Q (under damped) tank circuit. If the LTM8023 circuit is plugged into a live supply, the input voltage can ring to twice its nominal value, possibly exceeding the device's rating. This situation is easily avoided; see the Hot-Plugging Safely section.

Frequency Selection

The LTM8023 uses a constant frequency PWM architecture that can be programmed to switch from 200kHz to 2.4MHz by using a resistor tied from the R_T pin to ground. Table 2 provides a list of R_T resistor values and their resultant frequencies.

SWITCHING FREQUENCY (MHz)	R _T VALUE (kΩ)		
0.2	187		
0.3	124		
0.4	88.7		
0.5	69.8		
0.6	56.2		
0.7	46.4		
0.8	39.2		
0.9	34.6		
1.0	29.4		
1.2	23.7		
1.4	19.6		
1.6	15.8		
1.8	13.3		
2.0	11.5		
2.2	9.76		
2.4	8.66		

Table 2. Switching Frequency vs R_T Value

Operating Frequency Trade-Offs

It is recommended that the user apply the optimal R_T value given in Table 1 for the input and output operating condition. System level or other considerations, however, may necessitate another operating frequency. While the LTM8023 is flexible enough to accommodate a wide range of operating frequencies, a haphazardly chosen one may result in undesirable operation under certain operating or fault conditions. A frequency that is too high can reduce efficiency, generate excessive heat or even damage the LTM8023 if the output is overloaded or short circuited. A frequency that is too low can result in a final design that has too much output ripple or too large of an output capacitor.

The maximum frequency (and attendant R_T value) at which the LTM8023 should be allowed to switch is given in Table 1 in the $f_{(MAX)}$ column, while the recommended frequency (and R_T value) for optimal efficiency over the given input condition is given in the $f_{OPTIMAL}$ column.

There are additional conditions that must be satisfied if the synchronization function is used. Please refer to the Synchronization section for details.

BIAS Pin Considerations

The BIAS pin is used to provide drive power for the internal power switching stage and operate internal circuitry. For proper operation, it must be powered by at least 2.8V. If the output voltage is programmed to be 2.8V or higher, simply tie BIAS to V_{OUT} . If V_{OUT} is less than 2.8V, BIAS can be tied to V_{IN} or some other voltage source. In all cases, ensure that the maximum voltage at the BIAS pin is both less than 16V and the sum of V_{IN} and BIAS is less than 56V. If BIAS power is applied from a remote or noisy voltage source, it may be necessary to apply a decoupling capacitor locally to the LTM8023.



Load Sharing

Two or more LTM8023's may be paralleled to produce higher currents. To do this, tie the V_{IN} , ADJ, V_{OUT} and SHARE pins of all the paralleled LTM8023's together. To ensure that paralleled modules start up together, the RUN/SS pins may be tied together, as well. If the RUN/SS pins are not tied together, make sure that the same valued softstart capacitors are used for each module. An example of two LTM8023 modules configured for load sharing is given in the Typical Applications section.

For current sharing applications using multiple LTM8023s, the ADJ pins for all regulators may be combined using one resistor to ground as determined by:

$$R_{ADJ} = \frac{\frac{394.21}{N}}{V_{OUT} - 0.79}$$

where N is the number of paralleled modules and R_{ADJ} is in $\mathsf{k}\Omega.$

Burst Mode Operation

To enhance efficiency at light loads, the LTM8023 automatically switches to Burst Mode operation which keeps the output capacitor charged to the proper voltage while minimizing the input quiescent current. During Burst Mode operation, the LTM8023 delivers single cycle bursts of current to the output capacitor followed by sleep periods where the output power is delivered to the load by the output capacitor. In addition, V_{IN} and BIAS quiescent currents are reduced to typically 25µA and 50µA respectively during the sleep time. As the load current decreases towards a no load condition, the percentage of time that the LTM8023 operates in sleep mode increases and the average input current is greatly reduced, resulting in higher efficiency.

Burst Mode operation is enabled by tying SYNC to GND. To disable Burst Mode operation, tie SYNC to a stable voltage above 0.7V or synchronize to an external clock. *Do not leave the SYNC pin floating.*

Minimum Input Voltage

The LTM8023 is a step-down converter, so a minimum amount of headroom is required to keep the output in regulation. In addition, the input voltage required to turn on is higher than that required to run, and depends upon whether the RUN/SS is used. As shown in Figure 2, it takes only about $3.5V_{IN}$ for the LTM8023 to run a 3.3V output at light load. If RUN/SS is tied to V_{IN} , a 5.5V input voltage is required to start. If V_{IN} is allowed to settle in the operating region first then the RUN/SS pin is enabled, the minimum input voltage to start at light load is lower, about 4.2V. A similar curve for $5V_{OUT}$ operation is also provided in Figure 2.

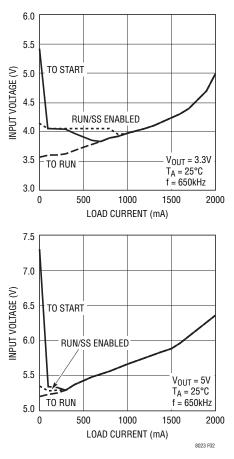


Figure 2. The LTM8023 Needs More Voltage to Start Than to Run



Soft-Start

The RUN/SS pin can be used to soft-start the LTM8023, reducing the maximum input current during start-up. The RUN/SS pin is driven through an external RC filter to create a voltage ramp at this pin. Figure 3 shows the start-up and shutdown waveforms with the soft-start circuit. By choosing an appropriate RC time constant, the peak start-up current can be reduced to the current that is required to regulate the output, with no overshoot. Choose the value of the resistor so that it can supply at least 20μ A when the RUN/SS pin reaches 2.5V.

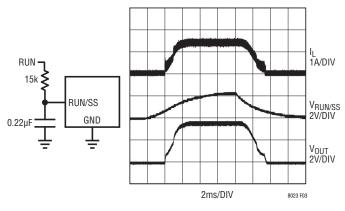


Figure 3. To Soft-Start the LTM8023, Add a Resistor and Capacitor to the RUN/SS Pin

Synchronization

The internal oscillator of the LTM8023 can be synchronized by applying an external 250kHz to 2MHz clock to the SYNC pin. *Do not leave this pin floating*. The resistor tied from the R_T pin to ground should be chosen such that the LTM8023 oscillates 20% lower than the intended synchronization frequency (see the Frequency Selection section).

The LTM8023 will not enter Burst Mode operation while synchronized to an external clock, but will instead skip pulses to maintain regulation.

Shorted Input Protection

Care needs to be taken in systems where the output will be held high when the input to the LTM8023 is absent. This may occur in battery charging applications or in battery backup systems where a battery or some other supply is diode OR-ed with the LTM8023's output. If the V_{IN} pin is allowed to float and the RUN/SS pin is held high (either by a logic signal or because it is tied to V_{IN}), then the LTM8023's internal circuitry will pull its guiescent current through its internal power switch. This is fine if your system can tolerate a few milliamps in this state. If you ground the RUN/SS pin, the internal power switch current will drop to essentially zero. However, if the V_{IN} pin is grounded while the output is held high, then parasitic diodes inside the LTM8023 can pull large currents from the output through the V_{IN} pin. Figure 4 shows a circuit that will run only when the input voltage is present and that protects against a shorted or reversed input.

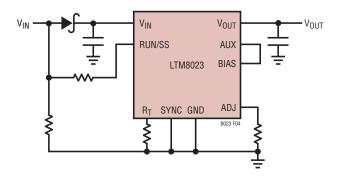


Figure 4. The Input Diode Prevents a Shorted Input from Discharging a Backup Battery Tied to the Output. It Also Protects the Circuit from a Reversed Input. The LTM8023 Runs Only When the Input is Present.



PCB Layout

Most of the headaches associated with PCB layout have been alleviated or even eliminated by the high level of integration of the LTM8023. The LTM8023 is nevertheless a switching power supply, and care must be taken to minimize EMI and ensure proper operation. Even with the high level of integration, you may fail to achieve specified operation with a haphazard or poor layout. See Figure 5 for a suggested layout.

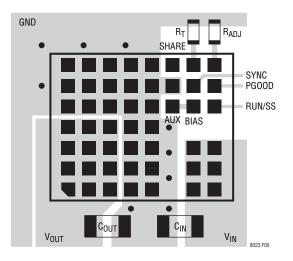


Figure 5. Layout Showing Suggested External Components, GND Plane and Thermal Vias

Ensure that the grounding and heatsinking are acceptable. A few rules to keep in mind are:

- 1. Place the R_{ADJ} and R_T resistors as close as possible to their respective pins.
- 2. Place the $C_{\rm IN}$ capacitor as close as possible to the $V_{\rm IN}$ and GND connection of the LTM8023.
- 3. Place the C_{OUT} capacitor as close as possible to the V_{OUT} and GND connection of the LTM8023.

- 4. Place the $C_{\rm IN}$ and $C_{\rm OUT}$ capacitors such that their ground current flow directly adjacent or underneath the LTM8023.
- 5. Connect all of the GND connections to as large a copper pour or plane area as possible on the top layer. Avoid breaking the ground connection between the external components and the LTM8023.
- 6. Use vias to connect the GND copper area to the boards internal ground plane. Liberally distribute these GND vias to provide both a good ground connection and thermal path to the internal planes of the printed circuit board.

Hot-Plugging Safely

The small size, robustness and low impedance of ceramic capacitors make them an attractive option for the input bypass capacitor of LTM8023. However, these capacitors can cause problems if the LTM8023 is plugged into a live supply (see Linear Technology Application Note 88 for a complete discussion). The low loss ceramic capacitor combined with stray inductance in series with the power source forms an underdamped tank circuit, and the voltage at the V_{IN} pin of the LTM8023 can ring to twice the nominal input voltage, possibly exceeding the LTM8023's rating and damaging the part. If the input supply is poorly controlled or the user will be plugging the LTM8023 into an energized supply, the input network should be designed to prevent this overshoot. Figure 6 shows the waveforms that result when an LTM8023 circuit is connected to a 24V supply through six feet of 24-gauge twisted pair. The first plot is the response with a 2.2µF ceramic capacitor at the input. The input voltage rings as high as 35V and the input current peaks at 20A. One method of damping the tank circuit is to add another capacitor with a series resistor to the circuit. In Figure 6c an aluminum electrolytic capacitor has been added. This capacitor's high equivalent series resistance damps the circuit and eliminates the voltage overshoot. The extra capacitor improves low frequency



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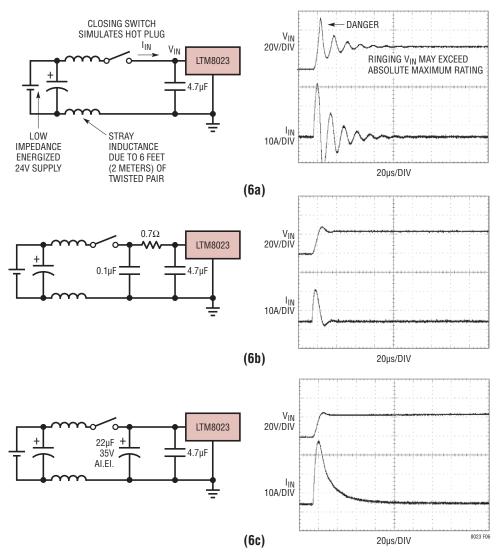


Figure 6. A Well Chosen Input Network Prevents Input Voltage Overshoot and Ensures Reliable Operation When the LTM8023 is Connected to a Live Supply

ripple filtering and can slightly improve the efficiency of the circuit, though it is likely to be the largest component in the circuit. An alternative solution is shown in Figure 6b. A0.7 Ω resistor is added in series with the input to eliminate the voltage overshoot (it also reduces the peak input current).

A 0.1μ F capacitor improves high frequency filtering. This solution is smaller and less expensive than the electrolytic capacitor. For high input voltages its impact on efficiency is minor, reducing efficiency less than one-half percent for a 5V output at full load operating from 24V.



Thermal Considerations

The LTM8023 output current may need to be derated if it is required to operate in a high ambient temperature or deliver a large amount of continuous power. The amount of current derating is dependent upon the input voltage, output power and ambient temperature. The temperature rise curves given in the Typical Performance Characteristics section can be used as a guide. These curves were generated by an LTM8023 mounted to a 33cm² 4-layer FR4 printed circuit board. Boards of other sizes and layer count can exhibit different thermal behavior, so it is incumbent upon the user to verify proper operation over the intended system's line, load and environmental operating conditions.

The thermal resistance numbers listed in the Pin Configuration are based on modeling the μ Module package mounted on a test board specified per JESD51-9 "Test Boards for Area Array Surface Mount Package Thermal Measurements." The thermal coefficients provided in this page are based on JESD 51-12 "Guidelines for Reporting and Using Electronic Package Thermal Information."

For increased accuracy and fidelity to the actual application, many designers use FEA to predict thermal performance. To that end, the Pin Configuration typically gives four thermal coefficients:

- θ_{JA} Thermal resistance from junction to ambient.
- θ_{JCbottom} Thermal resistance from junction to the bottom of the product case.
- θ_{JCtop} Thermal resistance from junction to top of the product case.
- θ_{JB} Thermal resistance from junction to the printed circuit board.

While the meaning of each of these coefficients may seem to be intuitive, JEDEC has defined each to avoid confusion and inconsistency. These definitions are given in JESD 51-12, and are quoted or paraphrased in the following:

• θ_{JA} is the natural convection junction-to-ambient air thermal resistance measured in a one cubic foot sealed enclosure. This environment is sometimes referred to as

"still air" although natural convection causes the air to move. This value is determined with the part mounted to a JESD 51-9 defined test board, which does not reflect an actual application or viable operating condition.

- $\theta_{JCbottom}$ is the junction-to-board thermal resistance with all of the component power dissipation flowing through the bottom of the package. In the typical µModule regulator, the bulk of the heat flows out the bottom of the package, but there is always heat flow out into the ambient environment. As a result, this thermal resistance value may be useful for comparing packages but the test conditions don't generally match the user's application.
- θ_{JCtop} is determined with nearly all of the component power dissipation flowing through the top of the package. As the electrical connections of the typical μ Module regulator are on the bottom of the package, it is rare for an application to operate such that most of the heat flows from the junction to the top of the part. As in the case of $\theta_{JCbottom}$, this value may be useful for comparing packages but the test conditions don't generally match the user's application.
- θ_{JB} is the junction-to-board thermal resistance where almost all of the heat flows through the bottom of the µModule regulator and into the board, and is really the sum of the $\theta_{JCbottom}$ and the thermal resistance of the bottom of the part through the solder joints and through a portion of the board. The board temperature is measured a specified distance from the package, using a two sided, two layer board. This board is described in JESD 51-9.

The most appropriate way to use the coefficients is when running a detailed thermal analysis, such as FEA, which considers all of the thermal resistances simultaneously. None of them can be individually used to accurately predict the thermal performance of the product, so it would be inappropriate to attempt to use any one coefficient to correlate to the junction temperature versus load graphs given in the LTM8023 data sheet.



A graphical representation of these thermal resistances is given in Figure 7.

The blue resistances are contained within the μ Module regulator, and the green are outside.

The die temperature of the LTM8023 must be lower than the maximum rating of 125°C, so care should be taken in the layout of the circuit to ensure good heat sinking of the LTM8023. The bulk of the heat flow out of the LTM8023 is through the bottom of the module and the LGA pads into the printed circuit board. Consequently a poor printed circuit board design can cause excessive heating, resulting in impaired performance or reliability. Please refer to the PCB Layout section for printed circuit board design suggestions.

Finally, be aware that at high ambient temperatures the internal Schottky diode will have significant leakage current increasing the quiescent current of the LTM8023.

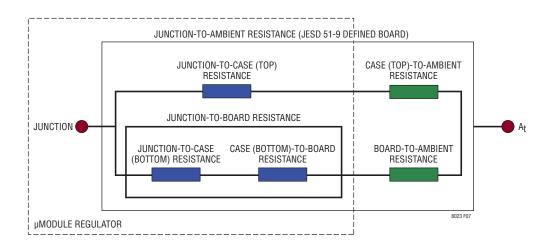
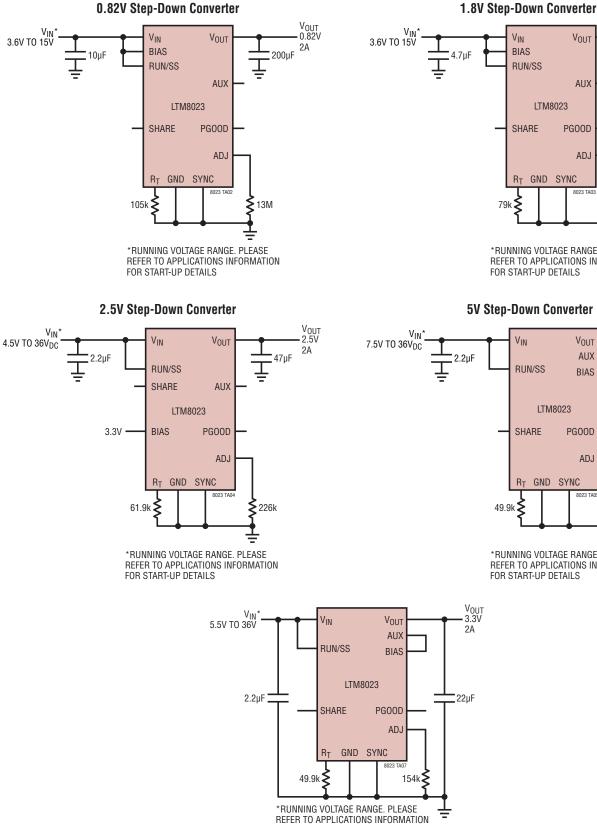
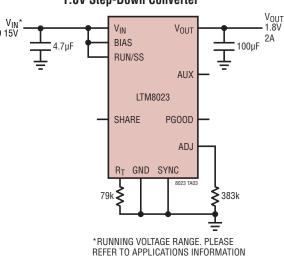


Figure 7



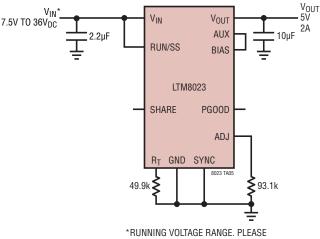
TYPICAL APPLICATIONS





FOR START-UP DETAILS

5V Step-Down Converter



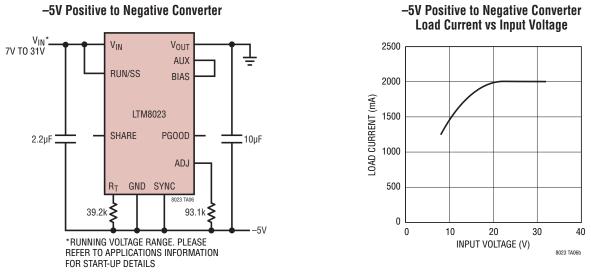
REFER TO APPLICATIONS INFORMATION FOR START-UP DETAILS

FOR START-UP DETAILS

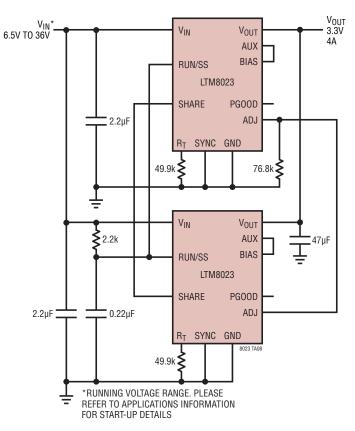


TYPICAL APPLICATIONS

-5V Positive to Negative Converter



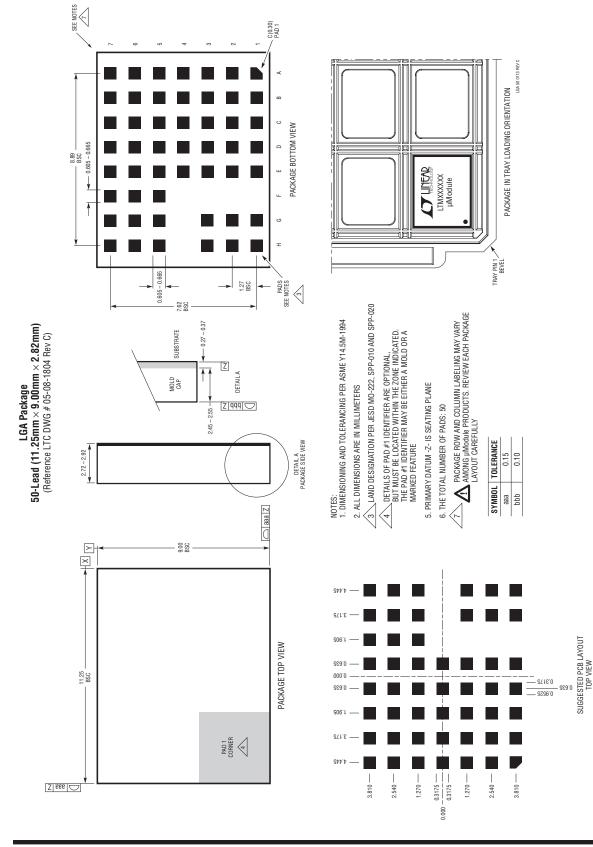
Two LTM8023's in Parallel, 3.3V at 4A





PACKAGE DESCRIPTION

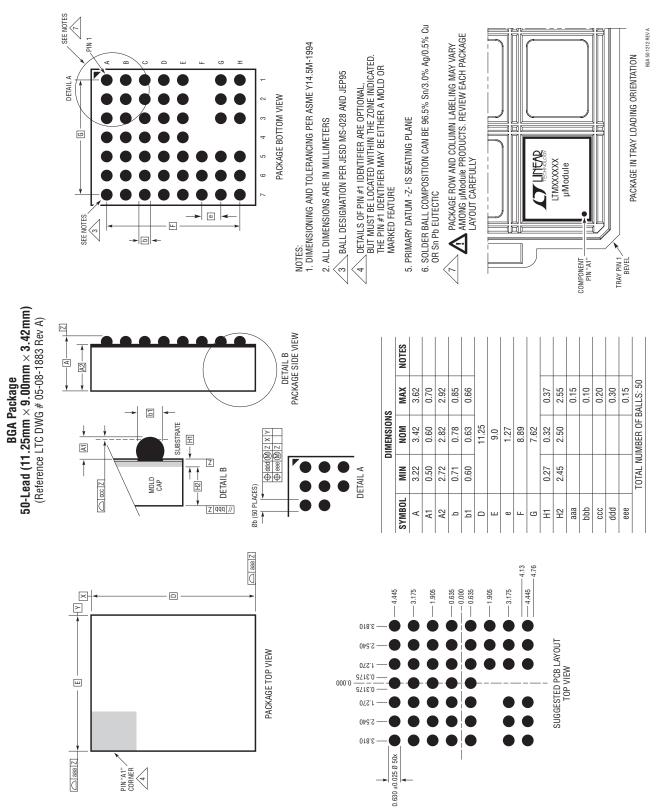
Please refer to http://www.linear.com/designtools/packaging/ for the most recent package drawings.



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PACKAGE DESCRIPTION

Please refer to http://www.linear.com/designtools/packaging/ for the most recent package drawings.





PACKAGE DESCRIPTION

PIN	SIGNAL DESCRIPTION	PIN	SIGNAL DESCRIPTION
A1	V _{OUT}	D5	GND
A2	V _{OUT}	D6	GND
A3	V _{OUT}	D7	GND
A4	V _{OUT}	E1	GND
A5	GND	E2	GND
A6	GND	E3	GND
A7	GND	E4	GND
B1	V _{OUT}	E5	GND
B2	V _{OUT}	E6	GND
B3	V _{OUT}	E7	GND
B4	V _{OUT}	F5	AUX
B5	GND	F6	GND
B6	GND	F7	SHARE
B7	GND	G1	V _{IN}
C1	V _{OUT}	G2	V _{IN}
C2	V _{OUT}	G3	V _{IN}
C3	V _{OUT}	G5	BIAS
C4	V _{OUT}	G6	SYNC
C5	GND	G7	R _T
C6	GND	H1	V _{IN}
C7	GND	H2	V _{IN}
D1	GND	H3	V _{IN}
D2	GND	H5	RUN/SS
D3	GND	H6	PGOOD
D4	GND	H7	ADJ

Table 3. Pin Assignment (Sorted by Pin Number)



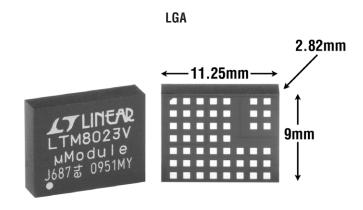
REVISION HISTORY (Revision history begins at Rev F)

REV	DATE	DESCRIPTION	PAGE NUMBER
F	8/10	Added Note 5	3
G	8/11	Added BGA package. Changes reflected throughout the data sheet.	1 to 24
Н	8/13	Changed output capacitor from 2.2µF to 22µF	1
Ι	2/14	Added SnPb BGA package option	1, 2
J	8/15	Updated thermal impedance values	2

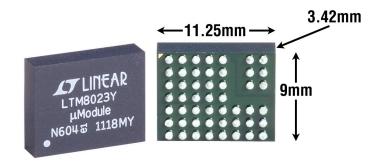




PACKAGE PHOTOGRAPHS







RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS		
LTM8022	36V, 1A Step-Down µModule Regulator	$0.8V \le V_{OUT} \le 10V$, Synchronizable, 9mm \times 11.25mm \times 2.8mm LGA		
LTM8025	36V, 3A Step-Down µModule Regulator	$0.8V \le V_{OUT} \le 24V$, Synchronizable, $9mm \times 15mm \times 4.3mm$ LGA		
LTM8027	60V, 4A Step-Down µModule Regulator	$2.5V \le V_{OUT} \le 24V$, Synchronizable, 15mm \times 15mm \times 4.3mm LGA		
LTM4612	EN55022B Certified 36V, 5A Step-Down µModule Regulator	$3.3V \le V_{OUT} \le 15V$, Synchronizable, $15mm \times 15mm \times 2.8mm$ LGA		
LTM4613	EN55022B Certified 36V, 8A Step-Down µModule Regulator	$3.3V \leq V_{OUT} \leq 15V,$ Synchronizable, $15mm \times 15mm \times 4.3mm$ LGA		
LTM8061	32V, 2A Li-Ion/Li-Polymer µModule Battery Charger	C/10 or Timer Termination, Auto-Recharge, Programmable Charge Current, $9mm \times 15mm \times 4.3mm$ LGA		



